

Data brief

# BlueNRG-LP, BlueNRG-LPS Bluetooth® LE Profiles SW package



### **Features**

- Bluetooth Low Energy profiles library SW package supporting the BlueNRG-LP, BlueNRG-LPS Bluetooth Low Energy (LE) system-on-chips
- Bluetooth Low Energy profiles binary libraries for central and peripheral roles
- Bluetooth Low Energy profiles APIs and event callback interfaces
- · Bluetooth Low Energy stack binary library
- Bluetooth Low Energy profiles test applications
- Bluetooth LE middlewares
- · BlueNRG-LP, BlueNRG-LPS CMSIS files
- BlueNRG-LP, BlueNRG-LPS peripheral drivers
- · BlueNRG-LP, BlueNRG-LPS SDK and HAL drivers
- · BlueNRG-LP, BlueNRG-LPS kit platforms support

### **Description**

The STSW-LP-PROFILES SW package provides the Bluetooth Low Energy standard profiles in binary format and supports the BlueNRG-LP, BlueNRG-LPS Bluetooth Low Energy (LE) system-on-chips.

The SW package also provides a set of profiles test applications allowing basic Bluetooth Low Energy (LE) profiles working scenarios to be demonstrated and the compliance with the Bluetooth LE profiles specifications to be tested.

Each profile test application comes with a complete set of headers, source files and project files.

The SW package supports the BlueNRG-LP, BlueNRG-LPS kit platforms available on the relative web pages.

Product summary		
BlueNRG-LP, BlueNRG-LPS Bluetooth LE Profiles SW package	STSW-LP- PROFILES	
Bluetooth® Low Energy/	BlueNRG-LP	
wireless system-on- chips	BlueNRG-LPS	
Evaluation platform based on the BlueNRG-LP	STEVAL-IDB011V1, STEVAL-IDB011V2	
Evaluation platform based on the BlueNRG-LPS	STEVAL-IDB012V1	
Applications	Wireless connectivity	



# **Revision history**

**Table 1. Document revision history** 

Date	Version	Changes
27-Jul-2020	1	Initial release.
14-Jun-2022	2	Added reference to the BlueNRG-LPS and related kit

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